

Solder balls, BGA SAC305, 762 µm



Solder balls for BGA, lead-free, 762 µm
 Alloy, Sn96,5Ag3Cu0,5 / SAC305
 PU = 50,000 pcs

item number	WL23622
model	HT00.1101 / VD90.5101
manufacturer	WEIDINGER
manufacturer item number	VD90.5101
order unit	1 PU
content unit	50000 piece